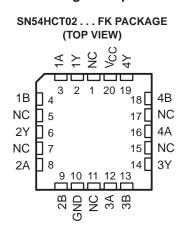
SCLS065E - NOVEMBER 1988 - REVISED JULY 2003

- Operating Voltage Range of 4.5 V to 5.5 V
- Outputs Can Drive Up To 10 LSTTL Loads
- Low Power Consumption, 20-μA Max I<sub>CC</sub>

SN54HCT02 ... J OR W PACKAGE SN74HCT02 ... D, DB, N, NS, OR PW PACKAGE (TOP VIEW)

- Typical t<sub>pd</sub> = 10 ns
- ±4-mA Output Drive at 5 V
- Low Input Current of 1 μA Max
- Inputs Are TTL-Voltage Compatible



NC - No internal connection

#### description/ordering information

These devices contain four independent 2-input NOR gates. They perform the Boolean function  $Y = \overline{A} \bullet \overline{B}$  or  $Y = \overline{A} + \overline{B}$  in positive logic.

ТА	PACKAGET		ORDERABLE PART NUMBER	TOP-SIDE MARKING	
	PDIP – N	Tube of 25	SN74HCT02N	SN74HCT02N	
		Tube of 50	SN74HCT02D		
	SOIC – D	Reel of 2500	SN74HCT02DR	HCT02	
		Reel of 250	SN74HCT02DT		
–40°C to 85°C	SOP – NS	Reel of 2000	SN74HCT02NSR	HCT02	
	SSOP – DB	Reel of 2000	SN74HCT02DBR	HT02	
		Tube of 90	SN74HCT02PW		
	TSSOP – PW	Reel of 2000	SN74HCT02PWR	HT02	
		Reel of 250	SN74HCT02PWT		
	CDIP – J	Tube of 25	SNJ54HCT02J	SNJ54HCT02J	
–55°C to 125°C	CFP – W	Tube of 150	SNJ54HCT02W	SNJ54HCT02W	
	LCCC – FK	Tube of 55	SNJ54HCT02FK	SNJ54HCT02FK	

#### **ORDERING INFORMATION**

† Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.



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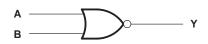


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FUNCTION TABLE (each gate)					
INP	INPUTS OUTPUT				
Α	В	Y			
Н	Х	L			
Х	Н	L			
L	L	н			

logic diagram, each gate (positive logic)



#### absolute maximum ratings over operating free-air temperature range (unless otherwise noted)<sup>†</sup>

Input clamp current, $I_{IK}$ ( $V_I < 0$ or $V_I > V_{CC}$ ) (see N Output clamp current, $I_{OK}$ ( $V_O < 0$ or $V_O > V_{CC}$ ) (see N Continuous output current, $I_O$ ( $V_O = 0$ to $V_{CC}$ ) Continuous current through $V_{CC}$ or GND Package thermal impedance, $\theta_{JA}$ (see Note 2): D	-0.5 V to 7 V Note 1)
	<i>N</i> package 113°C/W –65°C to 150°C

<sup>†</sup> Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTES: 1. The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

2. The package thermal impedance is calculated in accordance with JESD 51-7.

## recommended operating conditions (see Note 3)

			SN	154HCT02	SN	74HCT0	2	UNIT
			MIN	NOM MAX	MIN	NOM	MAX	UNIT
VCC	Supply voltage		4.5	5 🔥 5.5	4.5	5	5.5	V
VIH	High-level input voltage	V <sub>CC</sub> = 4.5 V to 5.5 V	2	N	2			V
VIL	Low-level input voltage	$V_{CC}$ = 4.5 V to 5.5 V		0.8			0.8	V
VI	Input voltage		0	Vcc	0		VCC	V
VO	Output voltage		0	S Vcc	0		VCC	V
$\Delta t/\Delta v$	Input transition rise/fall time		C	500			500	ns
Τ <sub>Α</sub>	Operating free-air temperature		-55	125	-40		85	°C

NOTE 3: All unused inputs of the device must be held at V<sub>CC</sub> or GND to ensure proper device operation. Refer to the TI application report, Implications of Slow or Floating CMOS Inputs, literature number SCBA004.



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electrical characteristics	over	recommended	operating	free-air	temperature	range	(unless
otherwise noted)					-	•	

DADAMETED	ARAMETER TEST CONDITIONS V <sub>C</sub>		Vcc	Т	A = 25°C	;	SN54H	ICT02	SN74HCT02		UNIT
PARAMETER			VCC	MIN	TYP	MAX	MIN	MAX	MIN	MAX	UNIT
Veu	$V_{I} = V_{IH} \text{ or } V_{IL}$	I <sub>OH</sub> = -20 μA	4.5 V	4.4	4.499		4.4		4.4		V
VOH	VI = VIH OL VIL	I <sub>OH</sub> = -4 mA	4.5 V	3.98	4.3		3.7	<u>h</u>	3.84		v
Ve	$\lambda = \lambda = 0$	I <sub>OL</sub> = 20 μA	4.5 V		0.001	0.1		0.1		0.1	V
VOL	$V_{I} = V_{IH} \text{ or } V_{IL}$	$I_{OL} = 4 \text{ mA}$	4.5 V		0.17	0.26		0.4		0.33	v
li	AI = ACC  or  0		5.5 V		±0.1	±100	~ ~	±1000		±1000	nA
ICC	$V_I = V_{CC} \text{ or } 0,$	$I_{O} = 0$	5.5 V			2	202	40		20	μA
∆lcc‡	One input at 0.5 V of Other inputs at 0 or	,	5.5 V		1.4	2.4	PPO4	3		2.9	mA
Ci			4.5 V to 5.5 V		3	10		10		10	pF

<sup>†</sup> This is the increase in supply current for each input that is at one of the specified TTL voltage levels, rather than 0 V or V<sub>CC</sub>.

# switching characteristics over recommended operating free-air temperature range, $C_L = 50 \text{ pF}$ (unless otherwise noted) (see Figure 1)

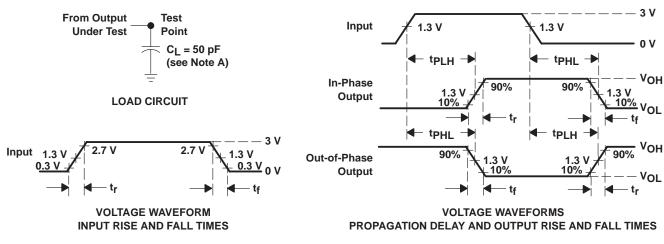
PARAMETER	FROM	то	то		ן = 25°C	;	SN54HCT02	SN74HCT02	UNIT
PARAMETER	(INPUT)	(OUTPUT)	Vcc	MIN	TYP	MAX	MIN MAX	MIN MAX	UNIT
÷.	A or B	V	4.5 V		11	20	30	25	20
<sup>t</sup> pd	AUB	I	5.5 V		10	18	27	22	ns
		V	4.5 V		9	15	22	19	
<sup>t</sup>		Y	5.5 V		8	14	20	17	ns

## operating characteristics, $T_{A}$ = 25°C

PARAMETER		TEST CONDITIONS	TYP	UNIT
Cpd	Power dissipation capacitance	No load	20	pF



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#### PARAMETER MEASUREMENT INFORMATION

NOTES: A. CL includes probe and test-fixture capacitance.

- B. Phase relationships between waveforms were chosen arbitrarily. All input pulses are supplied by generators having the following characteristics: PRR ≤ 1 MHz, Z<sub>Q</sub> = 50 Ω, t<sub>r</sub> = 6 ns, t<sub>f</sub> = 6 ns.
  - C. The outputs are measured one at a time with one input transition per measurement.
  - D.  $t_{PLH}$  and  $t_{PHL}$  are the same as  $t_{pd}$ .

#### Figure 1. Load Circuit and Voltage Waveforms



# N (R-PDIP-T\*\*)

PLASTIC DUAL-IN-LINE PACKAGE

16 PINS SHOWN



NOTES:

- A. All linear dimensions are in inches (millimeters).B. This drawing is subject to change without notice.
- Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
- $\triangle$  The 20 pin end lead shoulder width is a vendor option, either half or full width.



D (R-PDSO-G14)

PLASTIC SMALL-OUTLINE PACKAGE



NOTES: A. All linear dimensions are in inches (millimeters).

B. This drawing is subject to change without notice.

C. Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).

D. Falls within JEDEC MS-012 variation AB.



## MECHANICAL DATA

### PLASTIC SMALL-OUTLINE PACKAGE

#### 0,51 0,35 ⊕0,25⊛ 1,27 8 14 0,15 NOM 5,60 8,20 5,00 7,40 $\bigcirc$ Gage Plane ₽ 0,25 7 1 1,05 0,55 0°-10° Δ 0,15 0,05 Seating Plane — 2,00 MAX 0,10PINS \*\* 14 16 20 24 DIM 10,50 10,50 12,90 15,30 A MAX A MIN 9,90 9,90 12,30 14,70 4040062/C 03/03

NOTES: A. All linear dimensions are in millimeters.

NS (R-PDSO-G\*\*)

**14-PINS SHOWN** 

- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.



## **MECHANICAL DATA**

MTSS001C - JANUARY 1995 - REVISED FEBRUARY 1999

# PW (R-PDSO-G\*\*)

#### PLASTIC SMALL-OUTLINE PACKAGE

14 PINS SHOWN



NOTES: A. All linear dimensions are in millimeters.

- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.
- D. Falls within JEDEC MO-153



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